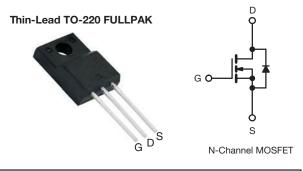
SiHA25N50E

Vishay Siliconix



E Series Power MOSFET



| PRODUCT SUMMARY | | | | | |
|--|------------------------------|--|--|--|--|
| V _{DS} (V) at T _J max. | 550 | | | | |
| R _{DS(on)} max. (Ω) at 25 °C | V _{GS} = 10 V 0.145 | | | | |
| Q _g max. (nC) | 86 | | | | |
| Q _{gs} (nC) | 14 | | | | |
| Q _{gd} (nC) | 25 | | | | |
| Configuration | Single | | | | |

FEATURES

- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATONS

- · Hard switched topologies
- Power factor correction power supplies (PFC)
- Switch mode power supplies (SMPS)
- Computing
 - PC silver box / ATX power supplies
- Lighting
- Two stage LED lighting

| ORDERING INFORMATION | | | | |
|---------------------------------|--------------------------|--|--|--|
| Package | Thin-Lead TO-220 FULLPAK | | | |
| Lead (Pb)-free | SiHA25N50E-E3 | | | |
| Lead (Pb)-free and halogen-free | SiHA25N50E-GE3 | | | |

| ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted) | | | | | | |
|--|-------------------------|---|-----------------------------------|-------------|-------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | | | V _{DS} | 500 | V | |
| Gate-source voltage | | | V _{GS} | ± 30 | V | |
| Continuous drain current (T _J = 150 °C) $^{\circ}$ | V _{GS} at 10 V | $T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$ | ۱ _D | 26 | | |
| | VGS AL TO V | T _C = 100 °C | | 16 | А | |
| Pulsed drain current ^a | | | I _{DM} | 50 | | |
| Linear derating factor | | | | 0.2 | W/°C | |
| Single pulse avalanche energy ^b | | | E _{AS} | 273 | mJ | |
| Maximum power dissipation | | | PD | 35 | W | |
| Operating junction and storage temperature range | | | T _J , T _{stg} | -55 to +150 | °C | |
| Drain-source voltage slope | $V_{DS} = 0 V t$ | o 80 % V _{DS} | -1) / / -14 | 65 | \//== | |
| Reverse diode dV/dt ^d | | | dV/dt | 25 | V/ns | |
| Soldering recommendations (peak temperature) ^c | for 10 s | | | 300 | °C | |
| Mounting torque M3 screw | | | | 0.6 | Nm | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.4 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

e. Limited by maximum junction temperature

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum junction-to-ambient | R _{thJA} | - | 65 | °C/W | |
| Maximum junction-to-case (drain) | R _{thJC} | - | 3.6 | 0/10 | |

S17-1308-Rev. E, 21-Aug-17

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Document Number: 91628



COMPLIANT HALOGEN

FREE Available

1

SiHA25N50E



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| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|--|---|------|-------|-------|------|
| Static | | • | | • | • | • | • |
| Drain-source breakdown voltage | V _{DS} | V _{GS} : | = 0 V, I _D = 250 μΑ | 500 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, I _D = 1 mA | - | 0.59 | - | V/°C |
| Gate-source threshold voltage (N) | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μΑ | 2.0 | - | 4.0 | V |
| | _ | $V_{GS} = \pm 20 \text{ V}$ | | - | - | ± 100 | nA |
| Gate-source leakage | I _{GSS} | | V _{GS} = ± 30 V | - | - | ± 1 | μA |
| Zaus asta valta sa shusia sumant | | V _{DS} = | = 500 V, V _{GS} = 0 V | - | - | 1 | μA |
| Zero gate voltage drain current | IDSS | V _{DS} = 400 \ | /, V _{GS} = 0 V, T _J = 125 °C | - | - | 25 | |
| Drain-source on-state resistance | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 12 A | - | 0.125 | 0.145 | Ω |
| Forward transconductance | 9 _{fs} | V _{DS} | = 30 V, I _D = 12 A | - | 6.6 | - | S |
| Dynamic | | • | | | | | |
| Input capacitance | C _{iss} | | V _{GS} = 0 V, | - | 1980 | - | - |
| Output capacitance | C _{oss} | | V _{DS} = 100 V, | - | 105 | - | |
| Reverse transfer capacitance | C _{rss} | | f = 1 MHz | - | 8 | - | |
| Effective output capacitance, energy related ^a | C _{o(er)} | | | - | 105 | - | pF |
| Effective output capacitance, time related ^b | C _{o(tr)} | $V_{\rm DS} = 0.0$ | $V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$ | | 285 | - | |
| Total gate charge | Qg | | | | 57 | 86 | nC |
| Gate-source charge | Q _{gs} | $V_{GS} = 10 \text{ V}$ $I_D = 12 \text{ A}, V_{DS} = 400 \text{ V}$ | | - | 14 | - | |
| Gate-drain charge | Q _{gd} | | | | 25 | - | |
| Turn-on delay time | t _{d(on)} | V _{DD} = 400 V, I _D = 12 A | | - | 19 | 38 | |
| Rise time | t _r | | | - | 36 | 72 | Π. |
| Turn-off delay time | t _{d(off)} | $R_g = 9$ | 9.1 Ω, V _{GS} = 10 V | - | 57 | 86 | ns |
| Fall time | t _f | | | - | 29 | 58 | |
| Gate input resistance | R _g | f = 1 MHz, open drain | | - | 0.56 | - | Ω |
| Drain-Source Body Diode Characteristic | s | • | | • | • | • | |
| Continuous source-drain diode current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 12 | • |
| Pulsed diode forward current | I _{SM} | | | - | - | 50 | - A |
| Diode forward voltage | V _{SD} | T _J = 25 °C, I _S = 16.5 A, V _{GS} = 0 V | | - | - | 1.2 | V |
| Reverse recovery time | t _{rr} | | | - | 338 | - | ns |
| Reverse recovery charge | Q _{rr} | $T_J = 25 \text{ °C}, I_F = I_S,$ dl/dt = 100 A/µs, V _R = 25 V | | - | 5.3 | - | μC |
| Reverse recovery current | I _{RRM} | | | - | 29 | - | A |

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

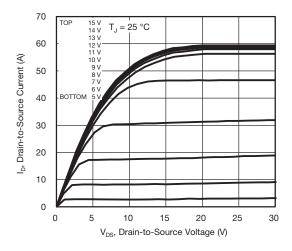
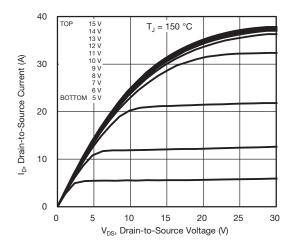


Fig. 1 - Typical Output Characteristics





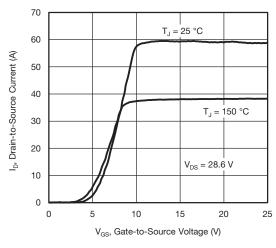


Fig. 3 - Typical Transfer Characteristics

S17-1308-Rev. E, 21-Aug-17

3.0 12 R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 0.5 0 -40 -60 -20 0 20 40 60 80 100 120 140 160 T_., Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

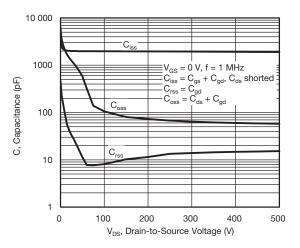


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

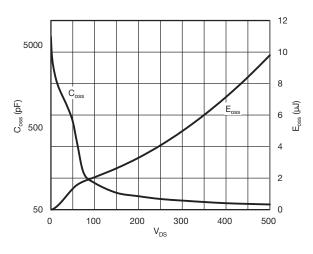


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

3

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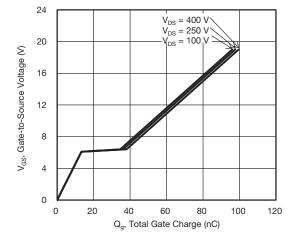


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

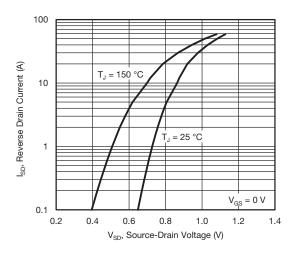


Fig. 8 - Typical Source-Drain Diode Forward Voltage

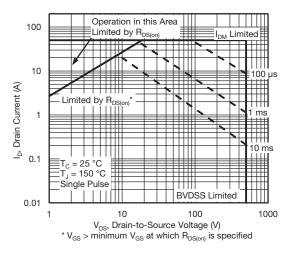


Fig. 9 - Maximum Safe Operating Area

30 24 I_D, Drain Current (A) 18 12 6 0 25 50 100 125 150 75 T_C, Case Temperature (°C)

Fig. 10 - Maximum Drain Current vs. Case Temperature

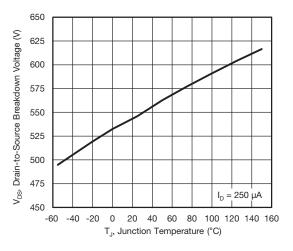


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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4

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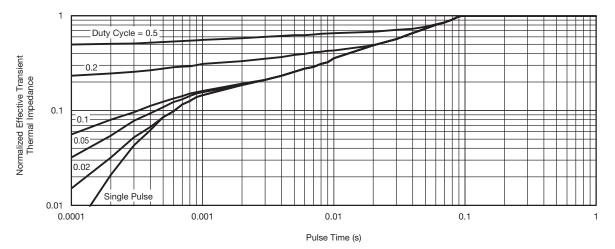


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

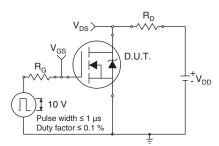


Fig. 13 - Switching Time Test Circuit

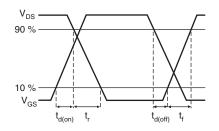


Fig. 14 - Switching Time Waveforms

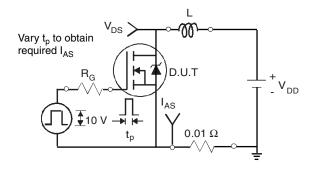


Fig. 15 - Unclamped Inductive Test Circuit

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5

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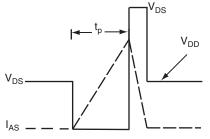


Fig. 16 - Unclamped Inductive Waveforms

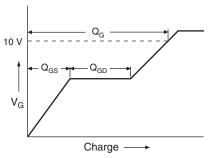
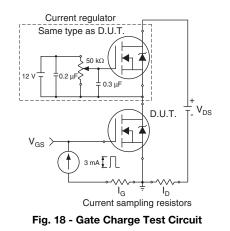
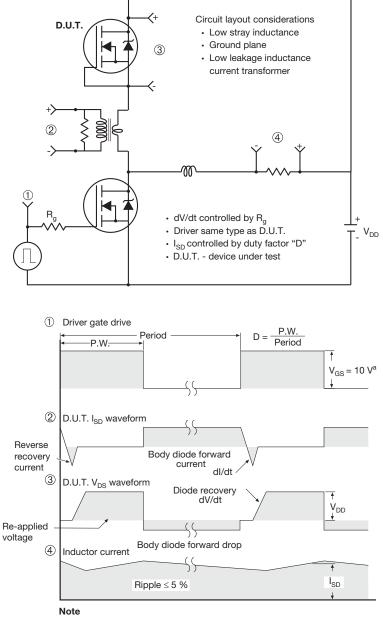


Fig. 17 - Basic Gate Charge Waveform





Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





| | | DIMEN | ISIONS | |
|---------------------------------------|------------|--------|--------|-------|
| SYMBOL | MILLIN | METERS | INC | HES |
| | MIN. | MAX. | MIN. | MAX. |
| А | 4.30 | 4.70 | 0.169 | 0.185 |
| A1 | 2.50 | 2.90 | 0.098 | 0.114 |
| A2 | 2.40 | 2.80 | 0.094 | 0.110 |
| b | 0.60 | 0.80 | 0.024 | 0.031 |
| b2 | 0.60 | 0.90 | 0.024 | 0.035 |
| С | - | 0.60 | - | 0.024 |
| D | 8.30 | 8.70 | 0.327 | 0.342 |
| d1 | 14.70 | 15.30 | 0.579 | 0.602 |
| d2 | 2.90 | 3.10 | 0.114 | 0.122 |
| d3 | 3.30 | 3.70 | 0.130 | 0.146 |
| E | 9.70 | 10.30 | 0.382 | 0.406 |
| е | 2.50 | 2.70 | 0.098 | 0.106 |
| L | 13.40 | 13.80 | 0.528 | 0.543 |
| L1 | 1.00 | 2.80 | 0.039 | 0.110 |
| ØP | 3.00 | 3.40 | 0.118 | 0.134 |
| ECN: E20-0684-Rev. D, 28 DWG: 6021 | 3-Dec-2020 | · | · | |

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